

### Product Summary

| $V_{(BR)DSS}$ | $R_{DS(on)TYP.}$  | $I_D@25^{\circ}C$ |
|---------------|-------------------|-------------------|
| 650V          | 26m $\Omega$ @18V | 105A              |

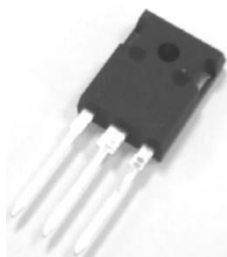
### Feature

- Wide bandgap SiC MOSFET technology
- Low On-Resistance with High Blocking Voltage
- Low Capacitances with High-Speed switching
- Low reverse recovery(Qrr)

### Application

- Switch mode power supplies
- Renewable energy
- Motor drives
- High voltage DC/DC converters

### Package

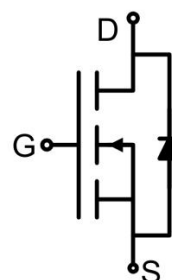


TO-247-3

### Marking



### Circuit diagram



### Absolute maximum ratings ( $T_C=25^{\circ}C$ unless otherwise noted)

| Parameter                | Symbol          | Test Condition                                        | Value      | Unit          |
|--------------------------|-----------------|-------------------------------------------------------|------------|---------------|
| Drain-Source Voltage     | $V_{DSmax}$     | $V_{GS} = 0V, I_D = 100\mu A$                         | 650        | V             |
| Gate-Source Voltage      | $V_{GSmax}$     | AC ( $f > 1 \text{ Hz}$ )                             | -10/+25    | V             |
| Gate-Source Voltage      | $V_{GSOP}$      | Static                                                | -4/+18     | V             |
| Continuous Drain Current | $I_D$           | $V_{GS} = 18V, T_C = 25^{\circ}C$                     | 105        | A             |
|                          | $I_D$           | $V_{GS} = 18V, T_C = 100^{\circ}C$                    | 74         | A             |
| Pulsed Drain Current     | $I_{D,pulse}$   | Pulse with $t_p$ limited by $T_{Jmax}$ at 1 ms        | 188        | A             |
|                          |                 | Pulse with $t_p$ limited by $T_{Jmax}$ at 100 $\mu s$ | 340        | A             |
| Power Dissipation        | $P_D$           | $T_C = 25^{\circ}C$                                   | 341        | W             |
| Thermal Resistance(Typ.) | $R_{\theta JC}$ | Junction-to-Case                                      | 0.44       | $^{\circ}C/W$ |
| Junction Temperature     | $T_J$           |                                                       | -55 ~ +175 | $^{\circ}C$   |
| Storage Temperature      | $T_{STG}$       |                                                       | -55 ~ +175 | $^{\circ}C$   |

### Electrical characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

| Parameter                          | Symbol                | Test Condition                                                                                          | Min. | Typ. | Max. | Unit |
|------------------------------------|-----------------------|---------------------------------------------------------------------------------------------------------|------|------|------|------|
| Static Characteristics             |                       |                                                                                                         |      |      |      |      |
| Drain-source breakdown voltage     | V <sub>(BR)DSS</sub>  | V <sub>GS</sub> = 0V, I <sub>D</sub> =100μA                                                             | 650  |      |      | V    |
| Zero gate voltage drain current    | I <sub>DSS</sub>      | V <sub>DS</sub> =650V,V <sub>GS</sub> = 0V,T <sub>J</sub> =25°C                                         |      | 1    | 50   | μA   |
| Gate-Source leakage current        | I <sub>GSS</sub>      | V <sub>GS</sub> =18V, V <sub>DS</sub> = 0V                                                              |      |      | 250  | nA   |
| Gate threshold voltage             | V <sub>GS(th)</sub>   | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =16mA                                                 |      | 3.0  |      | V    |
|                                    |                       | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =16mA ,T <sub>J</sub> =175°C                          |      | 2.0  |      |      |
| Drain-source on-resistance         | R <sub>DS(on)</sub>   | V <sub>GS</sub> =18V, I <sub>D</sub> =40A                                                               |      | 26   | 38   | mΩ   |
|                                    |                       | V <sub>GS</sub> =20V, I <sub>D</sub> =40A                                                               |      | 23   |      |      |
|                                    |                       | V <sub>GS</sub> =18V, I <sub>D</sub> =40A,T <sub>J</sub> =175°C                                         |      | 32   |      |      |
|                                    |                       | V <sub>GS</sub> =20V, I <sub>D</sub> =40A,T <sub>J</sub> =175°C                                         |      | 30   |      |      |
| Transconductance                   | g <sub>fs</sub>       | V <sub>GS</sub> =18V, I <sub>D</sub> =40A                                                               |      | 32   |      | S    |
|                                    |                       | V <sub>GS</sub> =18V, I <sub>D</sub> =40A,T <sub>J</sub> =175°C                                         |      | 30   |      |      |
| Dynamic characteristics            |                       |                                                                                                         |      |      |      |      |
| Input Capacitance                  | C <sub>iss</sub>      | V <sub>DS</sub> =600V,V <sub>GS</sub> =0V,f =1MHz<br>V <sub>AC</sub> =25mV                              |      | 3249 |      | pF   |
| Output Capacitance                 | C <sub>oss</sub>      |                                                                                                         |      | 193  |      |      |
| Reverse Transfer Capacitance       | C <sub>rss</sub>      |                                                                                                         |      | 14   |      |      |
| Total Gate Charge                  | Q <sub>g</sub>        | V <sub>DS</sub> =400V,V <sub>GS</sub> =-4V/18V,<br>I <sub>D</sub> =40A                                  |      | 138  |      | nC   |
| Gate-Source Charge                 | Q <sub>gs</sub>       |                                                                                                         |      | 68.7 |      |      |
| Gate-Drain Charge                  | Q <sub>gd</sub>       |                                                                                                         |      | 24.2 |      |      |
| Internal Gate Resistance           | R <sub>G(int)</sub>   | f =1MHz ,V <sub>AC</sub> =25mV                                                                          |      | 0.9  |      | Ω    |
| Turn-on delay time                 | t <sub>d(on)</sub>    | V <sub>DS</sub> =400V,V <sub>GS</sub> =-4/+18V,<br>I <sub>D</sub> =40A,R <sub>G(ext)</sub> =5Ω, L=293μH |      | 2.1  |      | nS   |
| Turn-on rise time                  | t <sub>r</sub>        |                                                                                                         |      | 25   |      |      |
| Turn-off delay time                | t <sub>d(off)</sub>   |                                                                                                         |      | 37   |      |      |
| Turn-off fall time                 | t <sub>f</sub>        |                                                                                                         |      | 13   |      |      |
| Turn-On Energy                     | E <sub>on</sub>       |                                                                                                         |      | 79   |      | μJ   |
| Turn-Off Energy                    | E <sub>off</sub>      |                                                                                                         |      | 175  |      |      |
| Total switching energy             | E <sub>tot</sub>      |                                                                                                         |      | 254  |      |      |
| Source-Drain Diode characteristics |                       |                                                                                                         |      |      |      |      |
| Diode Forward Current              | I <sub>S</sub>        | V <sub>GS</sub> =-4V,T <sub>C</sub> =25°C                                                               |      | 74   |      | A    |
| Diode Forward voltage              | V <sub>SD</sub>       | V <sub>GS</sub> =-4V, I <sub>SD</sub> =20A                                                              |      | 3.9  |      | V    |
|                                    |                       | V <sub>GS</sub> =-4V, I <sub>SD</sub> =20A,T <sub>J</sub> =175°C                                        |      | 3.5  |      |      |
| Diode Pulse Current                | I <sub>S, pulse</sub> | V <sub>GS</sub> = -4V, pulse width t <sub>p</sub> limited by T <sub>jmax</sub>                          |      | 188  |      | A    |
| Reverse Recovery Time              | t <sub>rr</sub>       | V <sub>GS</sub> =-4V,I <sub>SD</sub> = 40A,V <sub>R</sub> =400V<br>dif/dt = 4610 A/μs                   |      | 32   |      | nS   |
| Reverse Recovery Charge            | Q <sub>rr</sub>       |                                                                                                         |      | 881  |      | nC   |
| Peak Reverse Recovery Current      | I <sub>rrm</sub>      |                                                                                                         |      | 50   |      | A    |

## Typical Characteristics

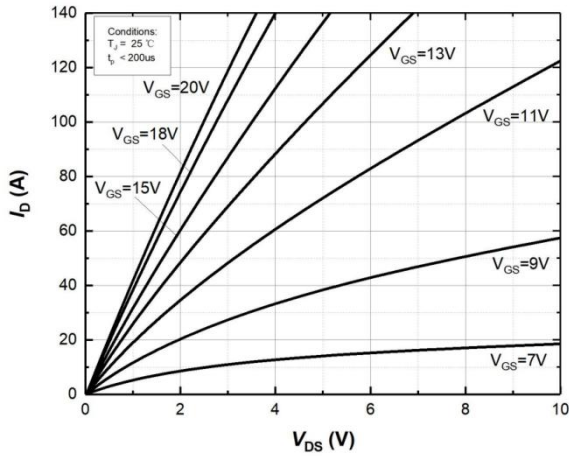


Figure 1. Output characteristics at  $T_j=25^\circ\text{C}$

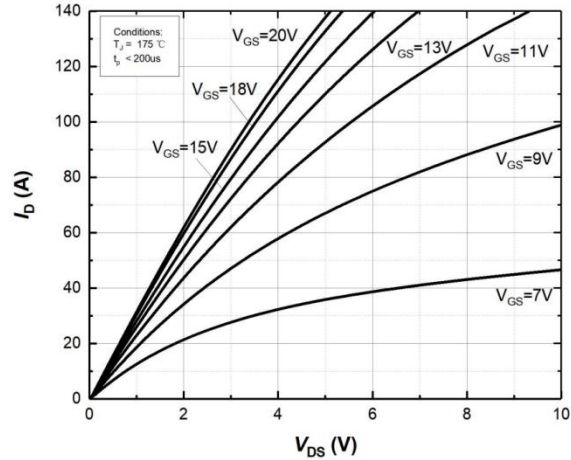


Figure 2. Output characteristics at  $T_j=175^\circ\text{C}$

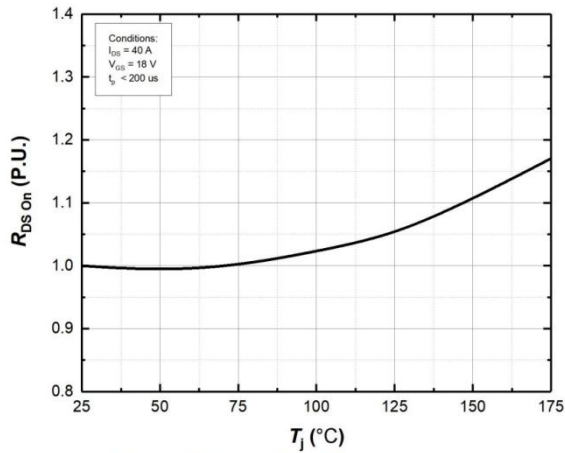


Figure 3. Normalized On-Resistance vs. Temperature

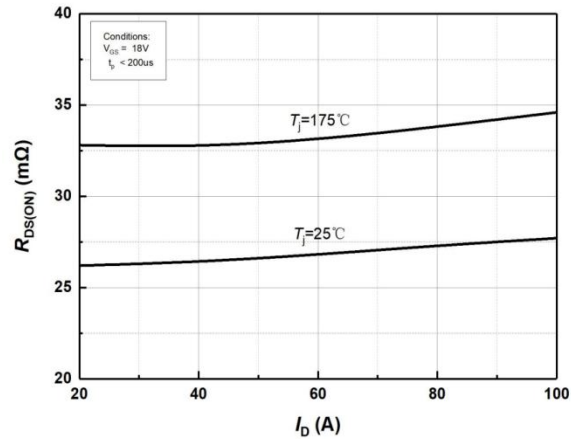


Figure 4. On-Resistance vs. Drain current for Various Temperature

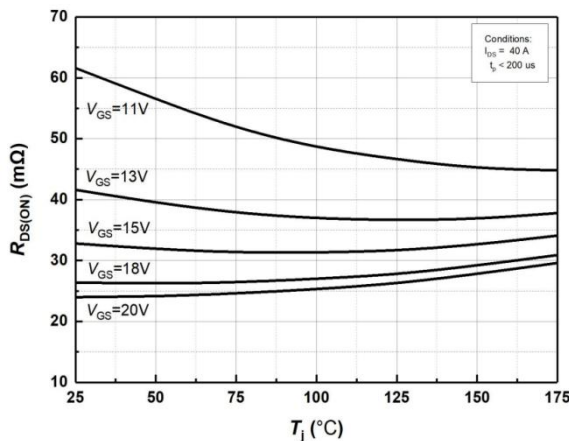


Figure 5. On-Resistance vs. Temperature for Various Gate Voltage

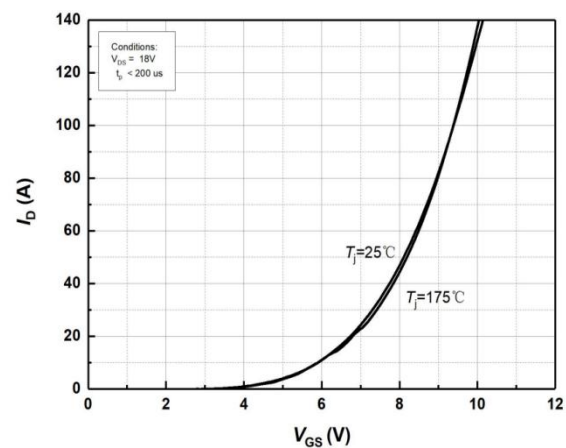


Figure 6. Transfer Characteristics for Various Junction Temperatures

## Typical Characteristics

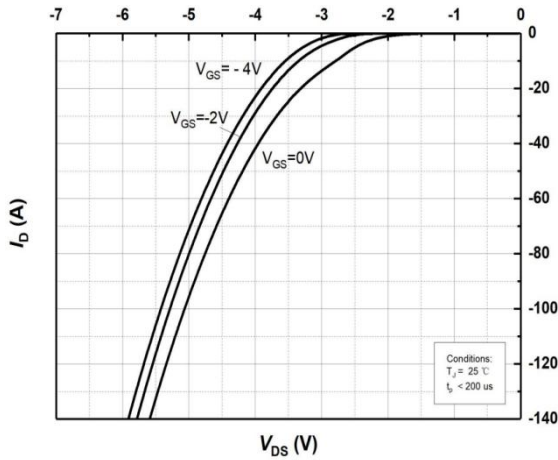


Figure 7. Body Diode Characteristics at Tj=25°C

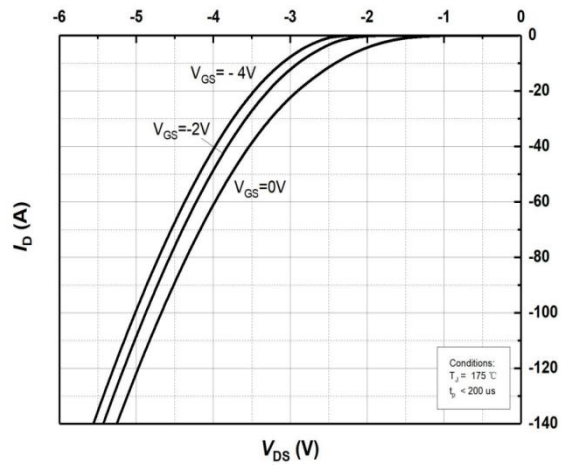


Figure 8. Body Diode Characteristics at Tj=175°C

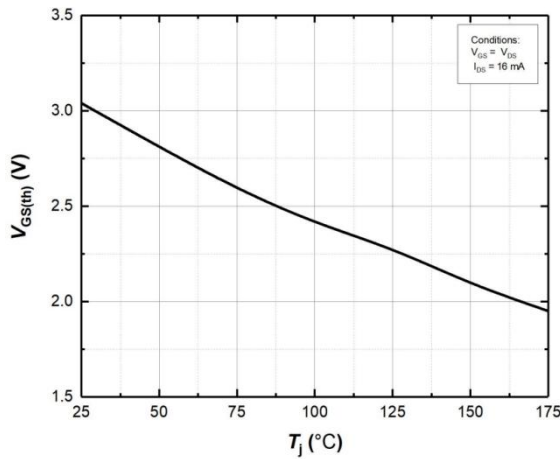


Figure 9. Threshold Voltage vs. Temperature

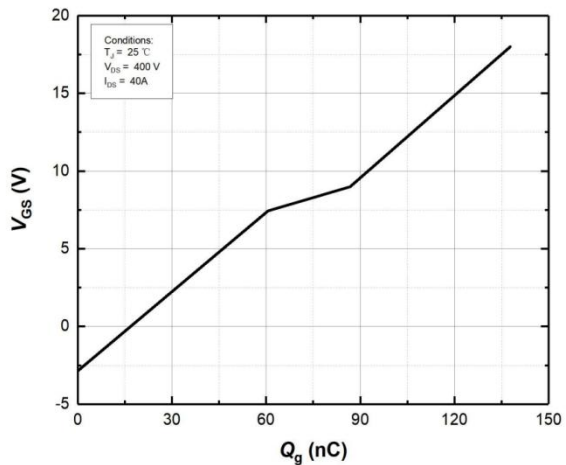


Figure 10 Gate Charge Characteristics

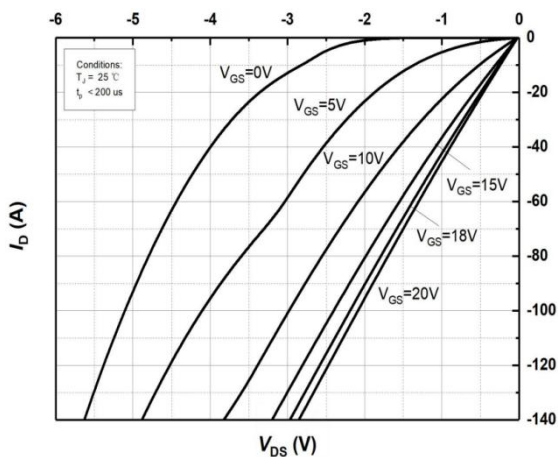


Figure 11. 3rd Quadrant Characteristic at Tj=25°C

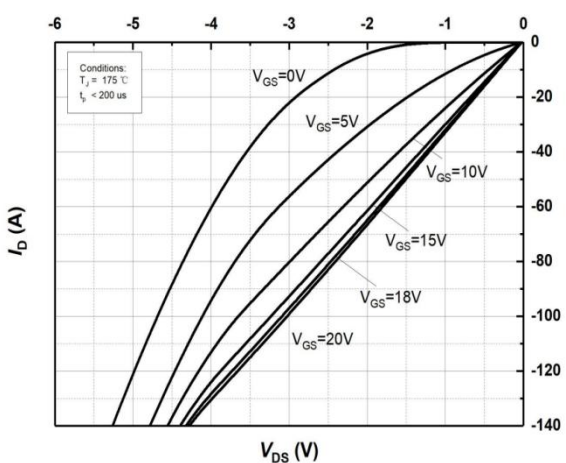


Figure 12. 3rd Quadrant Characteristic at Tj=175°C

### Typical Characteristics

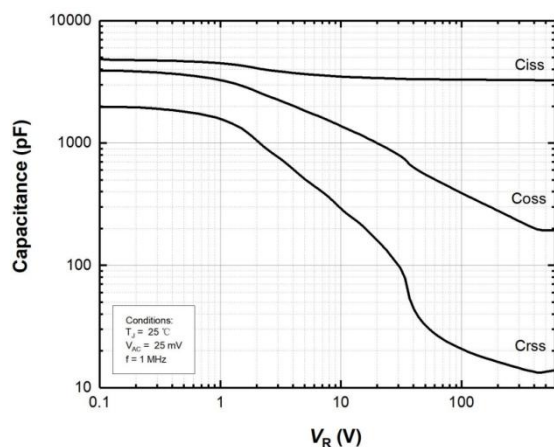


Figure 13. Capacitances vs. Drain-Source Voltage (0 – 1000V)

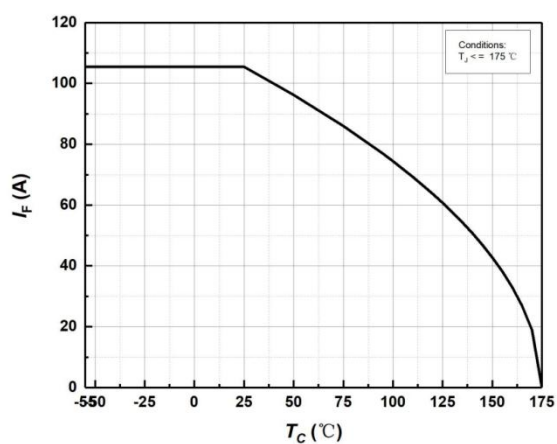


Figure 14. Continuous Drain Current Derating vs Case Temperature

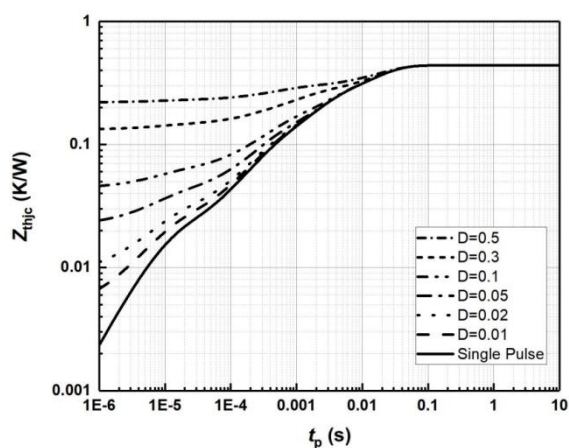


Figure 15. Transient Thermal Impedance (Junction – Case)

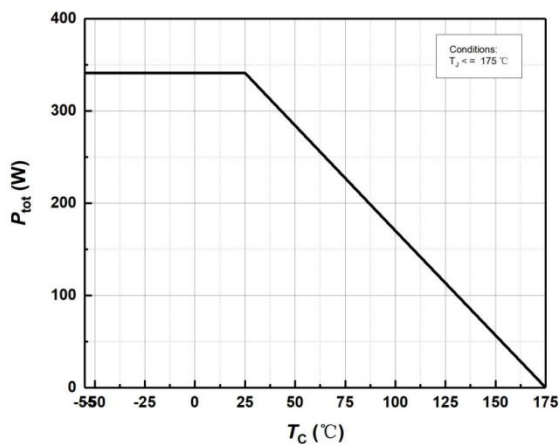


Figure 16. Maximum Power Dissipation Derating vs. Case Temperature

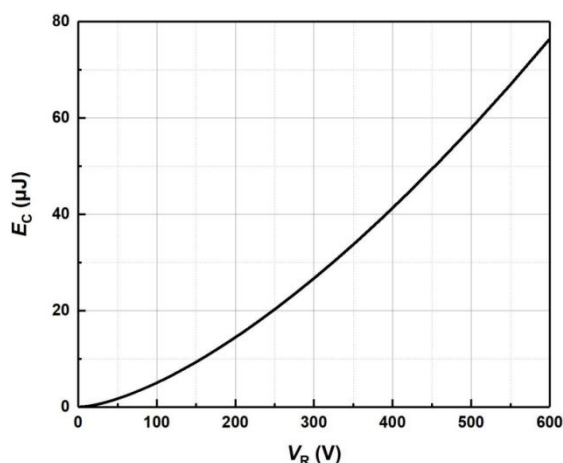


Figure 17. Output Capacitor Stored Energy

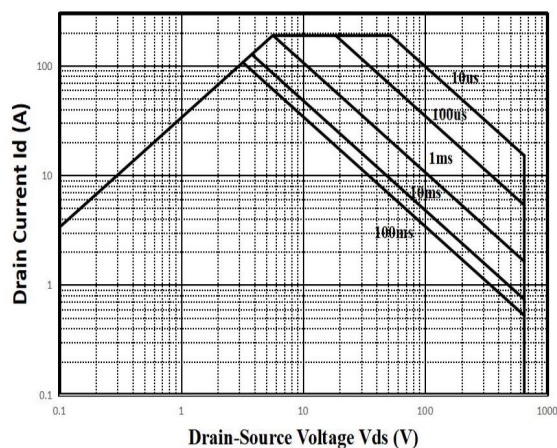


Figure 18. Safe Operating Area



### Typical Characteristics

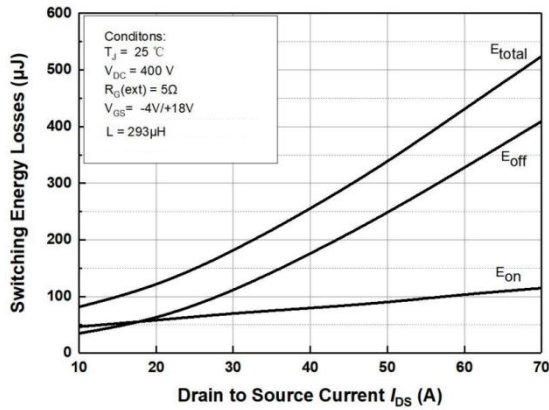


Figure 19. Clamped Inductive Switching Energy vs. Drain Current( $V_{DD} = 400\text{V}$ )

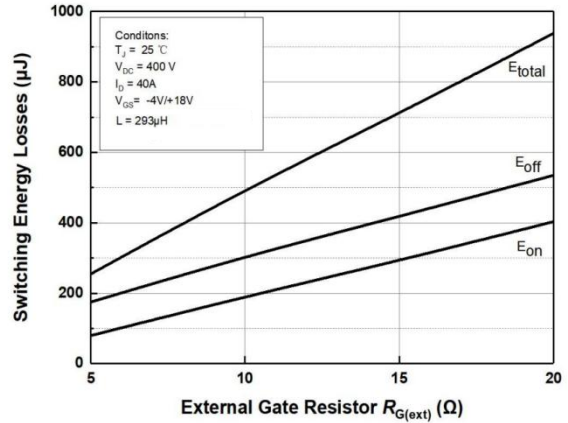


Figure 20. Clamped Inductive Switching Energy vs.  $R_{G(ext)}$

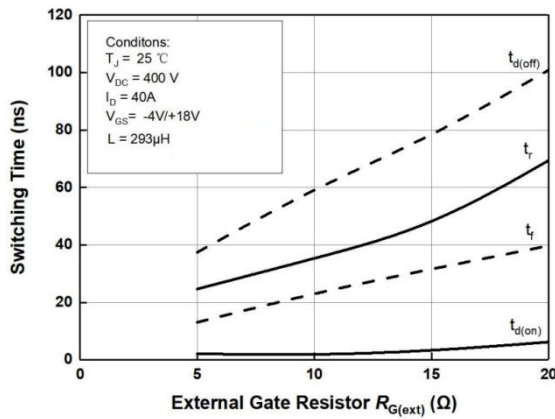
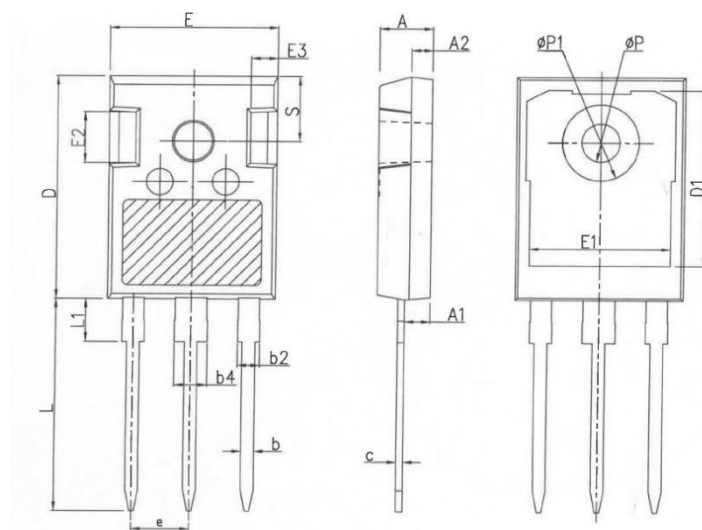


Figure 21. Switching Times vs.  $R_{G(ext)}$

### TO-247-3 Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 4.800                     | 5.200  | 0.189                | 0.205 |
| A1     | 2.210                     | 2.590  | 0.087                | 0.102 |
| A2     | 1.850                     | 2.150  | 0.073                | 0.085 |
| b      | 1.110                     | 1.360  | 0.044                | 0.054 |
| b2     | 1.910                     | 2.210  | 0.075                | 0.087 |
| b4     | 2.910                     | 3.210  | 0.115                | 0.126 |
| c      | 0.510                     | 0.750  | 0.020                | 0.030 |
| D      | 20.700                    | 21.300 | 0.815                | 0.839 |
| D1     | 16.250                    | 16.850 | 0.640                | 0.663 |
| E      | 15.500                    | 16.100 | 0.610                | 0.634 |
| E1     | 13.000                    | 13.600 | 0.512                | 0.535 |
| E2     | 4.800                     | 5.200  | 0.189                | 0.205 |
| E3     | 2.300                     | 2.700  | 0.091                | 0.106 |
| e      | 5.440 BSC                 |        | 0.214 BSC            |       |
| L      | 19.620                    | 20.220 | 0.772                | 0.796 |
| L1     | -                         | 4.300  | -                    | 0.169 |
| φP     | 3.400                     | 3.800  | 0.134                | 0.150 |
| φP1    | -                         | 7.300  | -                    | 0.287 |
| S      | 6.150 BSC                 |        | 0.242 BSC            |       |